



DIM. MIN. TYP. MAX.

* A	0.495 (12.57)		0.510 (12.95)
* B	0.286 (7.26)		0.299 (7.59)
C	0.088 (2.24)		0.105 (2.67)
E	0.390 (9.90)		0.419 (10.64)
F		0.450 (11.43)	
H	0.003 (0.08)		0.020 (0.51)
J	0.013 (0.33)		0.020 (0.51)
K		0.041 (1.04)	
K1		0.041 (1.04)	
L	0.016 (0.41)		0.050 (1.27)
P		0.050 (1.27)	
T	0.009 (0.23)		0.0125 (0.32)
W		45°	
X	0°		10°
Y		7°	

NOTE :

* A & B are reference datum's and do not include mold deflash or protrusions.

All dimensions in inches (mm.)

Angles are in degrees

Co-Planarity of leads within 0.004" (0.1mm)

TITLE		DRAWING No. D3	
20-pin SOIC Package (Wide)		D'WN	S.D.F. © C.M.L. 2003
		SHEET 1 OF 1	ISSUE 6